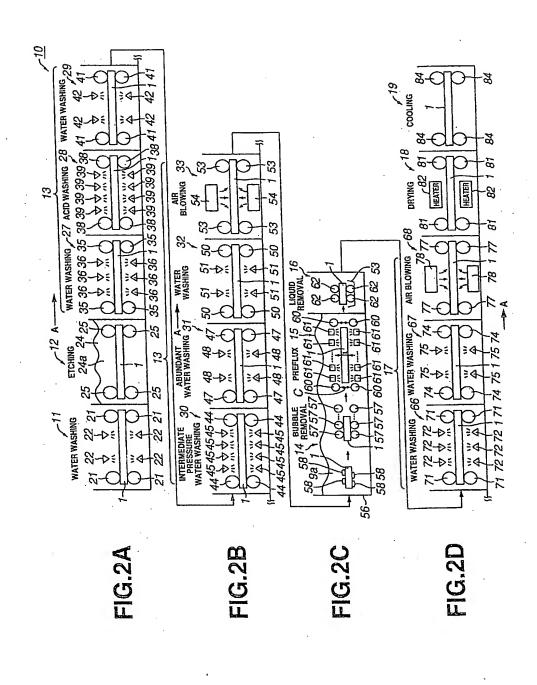


FIG.1



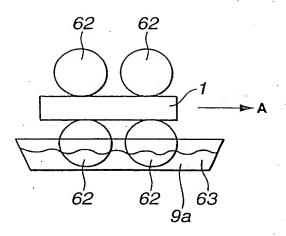


FIG.3

						Harry Poposition
		A CENT 11CED	TEMPERATURE	TRANSFER SPEED	PROCESSING	SPHAT PRESSONE
	PROCESS	WELL WATER		3m/min	EACH TWO SPRAY UNITS ABOVE AND BELOW	0.1MPa OR HIGHER
SIEPI	WAIEN WASHING	PRT-01 BY MECK INC.	30.0		DIP30s	
STEP2	SOFI ETCHING	SULFURATED WATER)			EACH THREE SPRAY UNITS	0.1MPa OR HIGHER
STEP3	WATER WASHING	WELL WATER	AMBIENI		ABOVE AND DELOW	agnoin ao care a
CTEP4	ACID WASHING	5% SULFURIC ACID	AMBIENT		ABOVE AND BELOW	0.ZMPa OK nienen
STEP5	WATER WASHING	PURE WATER	35°C		EACH TWO SPRAY UNITS ABOVE AND BELOW	0.1MPa OR HIGHER
STEP6	INTERMEDIATE	PURE WATER	35°C		EACH FOUR SPRAY UNITS ABOVE AND BELOW	0.5MPa OR HIGHER
CTED7	WAIEH WASHING	OTIDE WATER	35°C		EACH TWO SPRAY UNITS ABOVE AND BELOW	5L/cm².min OR HIGHER
215	WATER WASHING	FUNE WALE!			EACH TWO SPRAY UNITS	0.1MPa OR HIGHER
STEP8	FRESH WATER WASHING	PURE WATER	35°C		ABOVE AND BELOW	
STEP9	AIR BLOWING					
STEP10	1	TERFACE F2 BY SHIKOKU KASEI (MAIN COMPONENTS: AETIC ACID & IMIDAZOLE)	38.0		DIP120S+	
		200			ABOVE AND RELOW	
STEP11	PREFLUX	TERFACE F2 BY SHIKOKU KASEI (MAIN COMPONENTS: AETIC ACID & IMIDAZOLE)	35°C		אטטיים טיים איטטא	0.1MPa OR HIGHER
STEP12	LIGUID REMOVAL				PINIT OF BOAY HAITE	_
CTEP13	4	PIBE WATER	AMBIENT		ABOVE AND BELOW	0.1MPa OK HIGHER
2	WATER WASHING				EACH TWO SPRAY UNITS	0.1MPa OR HIGHER
STEP14	FRESH WATER WASHING	PURE WATER	AMBIENT		ABOVE AND BELOW	
STEP15	AIR BLOWING		0007		308	
STEP16	DRYING		Figures		208	
STEP17	COOLING		AMBIENI			

FIG.4

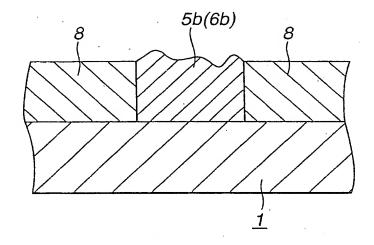


FIG.5

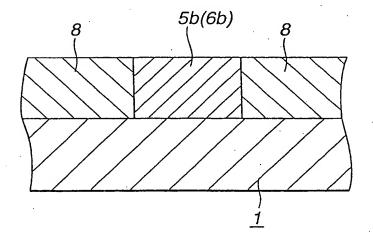


FIG.6

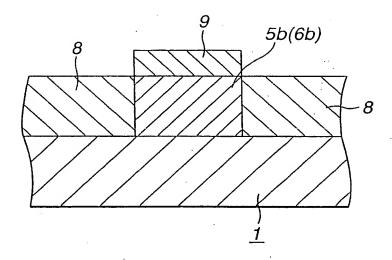


FIG.7